## Octal 3-State Bus Transceivers and D Flip-Flops <br> High-Performance Silicon-Gate CMOS

The KK74HC652A is identical in pinout to the LS/ALS652. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LS/ALSTTL outputs.

These devices consist of bus transceiver circuits, D-type flip-flop, and control circuitry arranged for multiplex transmission of data directly from the data bus or from the internal storage registers. Direction and Output Enable are provided to select the read-time or stored data function. Data on the A or B Data bus, or both, can be stored in the internal D flip-flops by low-to-high transitions at the appropriate clock pins (A-to-B Clock or B-to-A Clock) regardless of the select or enable or enable control pins. When A-to-B Source and B-to-A Source are in the real-time transfer mode, it is also possible to store data without using the internal D-type flip-flops by simulta-neously enabling Direction and Output Enable. In this configuration each output reinforces its input. Thus, when all other data sources to the two sets of bus lines are at high impedance, each set of bus lines will remain at its last state.

The KK74HC652A has noninverted outputs.

- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2.0 to 6.0 V
- Low Input Current: $1.0 \mu \mathrm{~A}$
- High Noise Immunity Characteristic of CMOS Devices


## LOGIC DIAGRAM

> PIN $24=\mathrm{V}_{\mathrm{CC}}$ PIN $12=\mathrm{GND}$


ORDERING INFORMATION KK74HC651AN Plastic KK74HC651ADW SOIC $\mathrm{T}_{\mathrm{A}}=-55^{\circ}$ to $125^{\circ} \mathrm{C}$ for all packages

## PIN ASSIGNMENT

A-TO-B
CLOCK
A-TO-B
SOURCE

MAXIMUM RATINGS*

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | DC Supply Voltage (Referenced to GND) | -0.5 to +7.0 | V |
| $\mathrm{~V}_{\mathrm{IN}}$ | DC Input Voltage (Referenced to GND) | -1.5 to $\mathrm{V}_{\mathrm{CC}}+1.5$ | V |
| $\mathrm{~V}_{\mathrm{OUT}}$ | DC Output Voltage (Referenced to GND) | -0.5 to $\mathrm{V}_{\mathrm{CC}}+0.5$ | V |
| $\mathrm{I}_{\mathrm{IN}}$ | DC Input Current, per Pin | $\pm 20$ | mA |
| $\mathrm{I}_{\mathrm{OUT}}$ | DC Output Current, per Pin | $\pm 35$ | mA |
| $\mathrm{I}_{\mathrm{CC}}$ | DC Supply Current, $\mathrm{V}_{\mathrm{CC}}$ and GND Pins | $\pm 75$ | mA |
| $\mathrm{P}_{\mathrm{D}}$ | Power Dissipation in Still Air, Plastic DIP+ |  |  |
| $\mathrm{TsOIC} \mathrm{Package+}$ | Storage Temperature | 750 | mW |
| $\mathrm{~T}_{\mathrm{L}}$ | Lead Temperature, 1 mm from Case for 10 Seconds <br> (Plastic DIP or SOIC Package) | 500 | ${ }^{\circ} \mathrm{C}$ |

*Maximum Ratings are those values beyond which damage to the device may occur.
Functional operation should be restricted to the Recommended Operating Conditions.

+ Derating - Plastic DIP: - $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ from $65^{\circ}$ to $125^{\circ} \mathrm{C}$
SOIC Package: : $-7 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ from $65^{\circ}$ to $125^{\circ} \mathrm{C}$


## RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Min | Max | Unit |
| :---: | :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | DC Supply Voltage (Referenced to GND) | 2.0 | 6.0 | V |
| $\mathrm{~V}_{\mathrm{IN}}, \mathrm{V}_{\mathrm{OUT}}$ | DC Input Voltage, Output Voltage (Referenced to GND) | 0 | $\mathrm{~V}_{\mathrm{CC}}$ | V |
| $\mathrm{T}_{\mathrm{A}}$ | Operating Temperature, All Package Types |  | -55 | +125 |
| $\mathrm{t}_{\mathrm{r}}, \mathrm{t}_{\mathrm{f}}$ | Input Rise and Fall Time | ${ }^{\circ} \mathrm{C}$ |  |  |
|  |  | (Figures2,3) | $\mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ | 0 |
|  |  | $\mathrm{~V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | 1000 | ns |
|  |  | $\mathrm{~V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | 0 | 500 |
|  |  |  |  |  |
|  |  |  | 0 | 400 |

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, $\mathrm{V}_{\text {IN }}$ and $\mathrm{V}_{\text {OUT }}$ should be constrained to the range $\mathrm{GND} \leq\left(\mathrm{V}_{\text {IN }}\right.$ or $\mathrm{V}_{\text {OUT }} \leq \mathrm{V}_{\mathrm{CC}}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or $\mathrm{V}_{\mathrm{CC}}$ ). Unused outputs must be left open. I/O pins must be connected to a properly terminated line or bus.

KK74HC652A

DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

| Symbol | Parameter | Test Conditions | $\begin{gathered} \mathrm{V}_{\mathrm{CC}} \\ \mathrm{~V} \end{gathered}$ | Guaranteed Limit |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | $\begin{gathered} 25^{\circ} \mathrm{C} \\ \text { to } \\ -55^{\circ} \mathrm{C} \end{gathered}$ | $\leq 85$ | $\begin{gathered} \leq 125 \\ { }^{\circ} \mathrm{C} \end{gathered}$ |  |
| $\mathrm{V}_{\mathrm{IH}}$ | Minimum HighLevel Input Voltage | $\begin{aligned} & \mathrm{V}_{\text {OUT }}=0.1 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{CC}}-0.1 \mathrm{~V} \\ & \left\|\mathrm{I}_{\text {OUT }}\right\| \leq 20 \mu \mathrm{~A} \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{gathered} 1.5 \\ 3.15 \\ 4.2 \end{gathered}$ | $\begin{gathered} 1.5 \\ 3.15 \\ 4.2 \end{gathered}$ | $\begin{gathered} 1.5 \\ 3.15 \\ 4.2 \end{gathered}$ | V |
| $\mathrm{V}_{\text {IL }}$ | Maximum Low Level Input Voltage | $\begin{aligned} & \mathrm{V}_{\text {OUT }}=0.1 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{CC}}-0.1 \mathrm{~V} \\ & \left\|\mathrm{I}_{\text {OUT }}\right\| \leq 20 \mu \mathrm{~A} \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 4.5 \\ & 6.0 \\ & \hline \end{aligned}$ | $\begin{gathered} \hline 0.5 \\ 1.35 \\ 1.8 \end{gathered}$ | $\begin{gathered} 0.5 \\ 1.35 \\ 1.8 \end{gathered}$ | $\begin{gathered} \hline 0.5 \\ 1.35 \\ 1.8 \\ \hline \end{gathered}$ | V |
| $\mathrm{V}_{\mathrm{OH}}$ | Minimum HighLevel Output Voltage |  | $\begin{aligned} & 2.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 1.9 \\ & 4.4 \\ & 5.9 \end{aligned}$ | $\begin{aligned} & 1.9 \\ & 4.4 \\ & 5.9 \end{aligned}$ | $\begin{aligned} & 1.9 \\ & 4.4 \\ & 5.9 \end{aligned}$ | V |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} \\ & \left\|\mathrm{I}_{\text {OUT }}\right\| \leq 6.0 \mathrm{~mA} \\ & \left\|\mathrm{I}_{\text {OUT }}\right\| \leq 7.8 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 3.98 \\ & 5.48 \end{aligned}$ | $\begin{aligned} & 3.84 \\ & 5.34 \end{aligned}$ | $\begin{aligned} & 3.7 \\ & 5.2 \end{aligned}$ |  |
| $\mathrm{V}_{\text {OL }}$ | Maximum LowLevel Output Voltage | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{IL}} \text { or } \mathrm{V}_{\mathrm{IH}} \\ & \left\|\mathrm{I}_{\mathrm{IOUT}}\right\| \leq 20 \mu \mathrm{~A} \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 0.1 \\ & 0.1 \\ & 0.1 \end{aligned}$ | $\begin{aligned} & 0.1 \\ & 0.1 \\ & 0.1 \end{aligned}$ | $\begin{aligned} & 0.1 \\ & 0.1 \\ & 0.1 \end{aligned}$ | V |
|  |  |  | $\begin{aligned} & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 0.26 \\ & 0.26 \end{aligned}$ | $\begin{aligned} & 0.33 \\ & 0.33 \end{aligned}$ | $\begin{aligned} & 0.4 \\ & 0.4 \end{aligned}$ |  |
| $\mathrm{I}_{\text {IN }}$ | Maximum Input Leakage Current | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{CC}} \text { or GND } \\ & \text { (Pins } 1,2,3,21,22 \text {, and } 23 \text { ) } \end{aligned}$ | 6.0 | $\pm 0.1$ | $\pm 1.0$ | $\pm 1.0$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{OZ}}$ | Maximum Three- <br> State Leakage Current | Output in High-Impedance <br> State $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{IL}} \text { or } \mathrm{V}_{\mathrm{IH}}$ <br> $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\mathrm{CC}}$ or GND, I/O Pins | 6.0 | $\pm 0.5$ | $\pm 5.0$ | $\pm 10$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{CC}}$ | Maximum Quiescent Supply Current (per Package) | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{CC}} \text { or } \mathrm{GND} \\ & \mathrm{I}_{\mathrm{OUT}}=0 \mu \mathrm{~A} \end{aligned}$ | 6.0 | 8.0 | 80 | 160 | $\mu \mathrm{A}$ |

AC ELECTRICAL CHARACTERISTICS (C $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$, Input $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=6.0 \mathrm{~ns}$ )

| Symbol | Parameter | $\begin{gathered} \mathrm{V}_{\mathrm{CC}} \\ \mathrm{~V} \end{gathered}$ | Guaranteed Limit |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\begin{gathered} 25^{\circ} \mathrm{C} \\ \text { to } \\ -55^{\circ} \mathrm{C} \end{gathered}$ | $\leq 85^{\circ} \mathrm{C}$ | $\leq 125^{\circ} \mathrm{C}$ |  |
| $\mathrm{t}_{\text {PLH }}, \mathrm{t}_{\text {PHL }}$ | Maximum Propagation Delay, Input A to Output B (or Input B to Output A) <br> (Figures 2,3 and 9) | $\begin{aligned} & 2.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{gathered} 180 \\ 36 \\ 31 \end{gathered}$ | $\begin{gathered} 225 \\ 45 \\ 38 \end{gathered}$ | $\begin{gathered} 270 \\ 54 \\ 46 \end{gathered}$ | ns |
| $\mathrm{t}_{\text {PLH }}, \mathrm{t}_{\text {PHL }}$ | Maximum Propagation Delay, A-to-B Clock to Output B (or B-to-A Clock to Output A) (Figures 1 and 9) | $\begin{aligned} & 2.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{gathered} 240 \\ 48 \\ 41 \end{gathered}$ | $\begin{gathered} 300 \\ 60 \\ 51 \\ \hline \end{gathered}$ | $\begin{gathered} 360 \\ 72 \\ 61 \\ \hline \end{gathered}$ | ns |
| $\mathrm{t}_{\text {PLH }}, \mathrm{t}_{\text {PHL }}$ | Maximum Propagation Delay, A-to-B Source to Output B (or B-to-A Source to Output A) (Figures 4 and 9) | $\begin{aligned} & 2.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{gathered} 220 \\ 44 \\ 37 \end{gathered}$ | $\begin{gathered} 275 \\ 55 \\ 47 \end{gathered}$ | $\begin{gathered} 330 \\ 66 \\ 56 \end{gathered}$ | ns |
| $\mathrm{t}_{\text {PLZ }}, \mathrm{t}_{\text {PHZ }}$ | Maximum Propagation Delay, Direction or Output Enable to Output A or B (Figures 5,6 and 10) | $\begin{aligned} & 2.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{gathered} 170 \\ 34 \\ 29 \end{gathered}$ | $\begin{gathered} 215 \\ 43 \\ 37 \end{gathered}$ | $\begin{gathered} 255 \\ 51 \\ 43 \end{gathered}$ | ns |
| $\mathrm{t}_{\text {PZL }}, \mathrm{t}_{\text {PZH }}$ | Maximum Propagation Delay, Direction or Output Enable to Output A or B (Figures 5,6 and 10) | $\begin{aligned} & 2.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{gathered} 180 \\ 36 \\ 31 \end{gathered}$ | $\begin{gathered} 225 \\ 45 \\ 38 \end{gathered}$ | $\begin{gathered} 270 \\ 54 \\ 46 \end{gathered}$ | ns |
| $\mathrm{t}_{\text {TLH }}, \mathrm{t}_{\text {THL }}$ | Maximum Output Transition Time, Any Output (Figure 2) | $\begin{aligned} & 2.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 60 \\ & 12 \\ & 10 \end{aligned}$ | $\begin{aligned} & 75 \\ & 15 \\ & 13 \end{aligned}$ | $\begin{aligned} & 90 \\ & 18 \\ & 15 \end{aligned}$ | ns |
| $\mathrm{C}_{\text {IN }}$ | Maximum Input Capacitance | - | 10 | 10 | 10 | pF |
| $\mathrm{C}_{\text {out }}$ | Maximum Three-State I/O Capacitance (Output in High-Impedance State | - | 15 | 15 | 15 | pF |


| $\mathrm{C}_{\mathrm{PD}}$ | Power Dissipation Capacitance (Per Channel) | Typical @25${ }^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}$ |  |
| :---: | :--- | :---: | :---: |
|  | Used to determine the no-load dynamic power <br> consumption: <br> $\mathrm{P}_{\mathrm{D}}=\mathrm{C}_{\mathrm{PD}} \mathrm{V}_{\mathrm{CC}}{ }^{2} \mathrm{f}+\mathrm{I}_{\mathrm{CC}} \mathrm{V}_{\mathrm{CC}}$ | 60 | pF |

TIMING REQUIREMENTS (Input $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=6.0 \mathrm{~ns}$ )

| Symbol | Parameter |  | $\mathrm{V}_{\mathrm{CC}}$ | Guaranteed Limit |  |  |
| :---: | :--- | :---: | :---: | :---: | :---: | :---: |
|  |  | V | $25^{\circ} \mathrm{C}$ to- $55^{\circ} \mathrm{C}$ | $\leq 85^{\circ} \mathrm{C}$ | $\leq 125^{\circ} \mathrm{C}$ | Unit |
|  | Minimum Setup Time, Input A to | 2.0 | 50 | 65 | 75 | ns |
|  | A-to-B Clock (or Input B to B-to-A | 4.5 | 10 | 13 | 15 |  |
|  | Clock) (Figure 7) | 6.0 | 9 | 11 | 13 |  |
| $\mathrm{t}_{\mathrm{h}}$ | Minimum Hold Time, A-to-B Clock | 2.0 | 25 | 30 | 40 | ns |
|  | to Input A (or B-to-A Clock to | 4.5 | 5 | 6 | 8 |  |
|  | Input B) (Figure 7) | 6.0 | 5 | 5 | 7 |  |
| $\mathrm{t}_{\mathrm{w}}$ | Minimum Pulse Width, A-to-B Clock | 2.0 | 75 | 95 | 110 | ns |
|  | (or B-to-A Clock) | 4.5 | 15 | 19 | 22 |  |
|  | (Figure 7) | 6.0 | 13 | 16 | 19 |  |
| $\mathrm{t}_{\mathrm{r}}, \mathrm{t}_{\mathrm{f}}$ | Maximum Input Rise and Fall Times | 2.0 | 1000 | 1000 | 1000 | ns |
|  | (Figures 2 and 3) | 4.5 | 500 | 500 | 500 |  |
|  |  | 6.0 | 400 | 400 | 400 |  |

TIMING DIAGRAM


KK74HC652A

FUNCTION TABLE

| Dir. | OE | CAB | CBA | SAB | SBA | A | B | FUNCTION |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| L | H |  |  |  |  | INPUTS | INPUTS | Both the A bus and the B bus are inputs. |
|  |  | X | X | X | X | Z | Z | The output functions of the $A$ and $B$ bus are disabled. |
|  |  | 5 | 5 | X | X | INPUTS | INPUTS | Both the A and B bus are used for inputs to the internal flip-flops. Data at the bus will be stored on low to high transition of the clock inputs. |
| L | L |  |  |  |  | OUTPUTS | INPUTS | The A bus are outputs and the B bus are inputs. |
|  |  | $\mathrm{X}^{*}$ | X | X | L | $\begin{aligned} & \hline \mathrm{L} \\ & \mathrm{H} \end{aligned}$ | $\begin{aligned} & \hline \mathrm{L} \\ & \mathrm{H} \end{aligned}$ | The data at the B bus are displayed at the A bus. |
|  |  | $\mathrm{X}^{*}$ | 5 | X | L | $\begin{aligned} & \mathrm{L} \\ & \mathrm{H} \end{aligned}$ | $\begin{aligned} & \mathrm{L} \\ & \mathrm{H} \end{aligned}$ | The data at the B bus are displayed at the A bus. The data of the B bus are stored to the internal flip-flops on low to high transition of the clock pulse. |
|  |  | $\mathrm{X}^{*}$ | X | X | H | Qn | X | The data stored to the internal flip-flops, are displayed at the A bus. |
|  |  | X* | 5 | X | H | $\begin{aligned} & \mathrm{H} \\ & \mathrm{~L} \end{aligned}$ | $\begin{gathered} \mathrm{H} \\ \mathrm{~L} \end{gathered}$ | The data at the B bus are stored to the internal flip-flops on low to high transition of the clock pulse. The states of the internal flip-flops output directly to the A bus. |
| H | H |  |  |  |  | INPUTS | OUTPUTS | The A bus are inputs and the B bus are outputs. |
|  |  | X | $\mathrm{X}^{*}$ | L | X | $\begin{aligned} & \hline \mathrm{L} \\ & \mathrm{H} \end{aligned}$ | $\begin{aligned} & \hline \mathrm{L} \\ & \mathrm{H} \end{aligned}$ | The data at the A bus are displayed at the B bus. |
|  |  | F | $\mathrm{X}^{*}$ | L | X | $\begin{aligned} & \mathrm{L} \\ & \mathrm{H} \end{aligned}$ | $\begin{aligned} & \mathrm{L} \\ & \mathrm{H} \end{aligned}$ | The data at the B bus are displayed at the A bus. The data of the B bus are stored to the internal flip-flops on low to high transition of the clock pulse. |
|  |  | X | $\mathrm{X}^{*}$ | H | X | X | Qn | The data stored to the internal flip-flops are displayed at the B bus. |
|  |  | 5 | $\mathrm{X}^{*}$ | H | X | $\begin{aligned} & \mathrm{L} \\ & \mathrm{H} \end{aligned}$ | $\begin{aligned} & \mathrm{L} \\ & \mathrm{H} \end{aligned}$ | The data at the A bus are stored to the internal flip-flops on low to high transition of the clock pulse. The states of the internal flip-flops output directly to the B bus. |
| H | L |  |  |  |  | OUTPUTS | OUTPUTS | Both the A bus and the B bus are outputs |
|  |  | X | X | H | H | Qn | Qn | The data stored to the internal flip-flops are displayed at the A and B bus respectively. |
|  |  | F | 5 | H | H | Qn | Qn | The output at the A bus are displayed at the B bus, the output at the B bus are displayed at the A bus respec. |

## X : DON'T CARE

Z : HIGH IMPEDANCE
Qn : THE DATA STORED TO THE INTERNAL FLIP-FLOPS BY MOST RECENT LOW TO HIGH TRANSITION
OF THE CLOCK INPUTS
*: THE DATA AT THE A AND B BUS WILL BE STORED TO THE INTERNAL FLIP-FLOPS ON EVERY LOW TO TRANSITION OF THE CLOCK INPUTS

## SWITCHING DIAGRAMS



Figure 1. Switching Waveforms


Figure 2. $\mathbf{A}$ Data Port $=$ Input, $\mathbf{B}$ Data Port $=$ Output


Figure 4. Switching Waveforms


Figure 3. A Data Port = Output, B Data Port = Input


Figure 5. Switching Waveforms


Figure 6. Switching Waveforms


Figure 7. Switching Waveforms


Figure 9. Test Circuit
Figure 10. Test Circuit

EXPANDED LOGIC DIAGRAM


## N S UFFIX PLASTIC DIP

(MS - 001AF)


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| :--- |

## NOTES:

1. Dimensions "A", "B" do not include mold flash or protrusions.

Maximum mold flash or protrusions $0.25 \mathrm{~mm}(0.010)$ per side.

D SUFFIX SOIC
(MS - 013AD)


|  | Dimension, mm |  |
| :---: | :---: | :---: |
| Symbol | MIN | MAX |
| A | 15.2 | 15.6 |
| B | 7.4 | 7.6 |
| C | 2.35 | 2.65 |
| D | 0.33 | 0.51 |
| F | 0.4 | 1.27 |
| G | 1.27 |  |
| H | 9.53 |  |
| J | $00^{\circ}$ | $8{ }^{\circ}$ |
| K | 0.1 | 0.3 |
| M | 0.23 | 0.32 |
| P | 10 | 10.65 |
| R | 0.25 | 0.75 |

